# **SHOULDER**

规格书编号 SPEC NO:

# 产品规格书 SPECIFICATION

CUSTOMER 客户:	
PRODUCT 产品:	SAW FILTER
MODEL NO 型 号:	HDAF58A1Dc SIP5Dc
PREPARED 编 制:	CHECKED 审 核:
APPROVED 批 准:	<b>DATE</b> 日期: 2011-3-23

客户确认 CUSTOMER RECEIVED:						
审核 CHECKED	批准 APPROVED	日期 DATE				

# 无锡市好达电子有限公司 Shoulder Electronics Limited

## HDAF58A1Dc SIP5Dc

# 更改历史记录 History Record

更改日期 Date	规格书编号 Spec. No.	产品型号 Part No.	客户产品型号 Customer No.	更改内容描述 Modify Content	备注 Remark

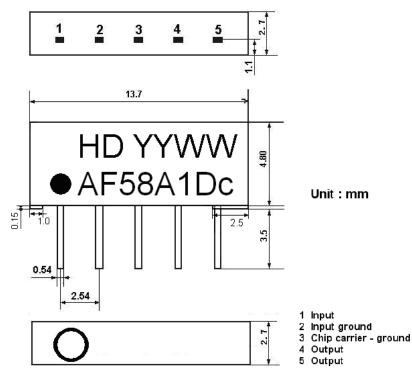
### **1.SCOPE**

SAW FILTER

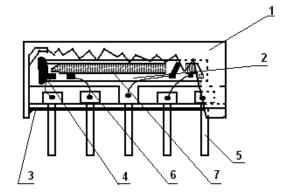
SHOULDER'S SAW filter series have broad line up products meeting all broadcast standard including NTSC,PAL and SECAM systems. These filters are composed of two interdigital transducers on a single-crystal. piezoelectrical chip. they are used in electronic equipments such as TV and so on.

### **2.**Construction

2.1 Dimension and materials Manufacturer's name : SHOULDER ELECTRONICS Co. LTD(CHINA) Type : AF58A1Dc



YY:year WW:week

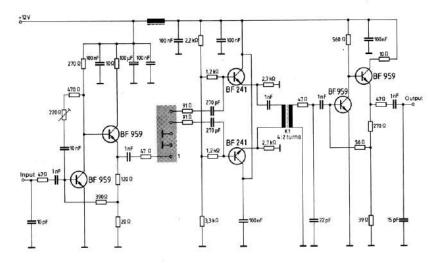


Components	Materials
1.Outer casing	PPS
2.Substrate	Lithium niobate
3.Base	Epoxy resin
4.Absorber	Epoxy resin
5.Lead	Cu alloy+Ni plate+Sn enameled
6.Bonding wire	AlSi alloy
7.Electrode	AI

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# SAW FILTER

#### 2.2. Circuit construction, measurement circuit



Test circuit for SIP-5 filter Input impedance of the symmetrical post-amplifier: 2 k $\Omega$  in parallel with 3 pF

### **3.**Characteristics

Items	Conditions	Specifications
Standard atmospheric conditions	Unless otherwise specified , the standard rang of atmospheric conditions for making measurements and tests is as follows; Ambient temperature $: 15^{\circ}$ C to $35^{\circ}$ C Relative humidity $: 25\%$ to $85\%$ Air pressure $: 86$ kPa to $106$ kPa	
Operating temperature rang	Operating temperature rang is the rang of ambient temperatures in which the filter can be operated continuously. $-25^{\circ}C \sim +65^{\circ}C$	There shall be no damage.
Storage temperature rang	Storage temperature rang is the rang of ambient temperatures at which the filter can be stored without damage. Conditions are as specified elsewhere in these specifications. $-40^{\circ}$ C ~ $+85^{\circ}$ C	
Reference temperature	+25°C	]

### 3.1 Maximum Rating

DC voltage	VDC	12	V	Between any terminals
AC voltage	Vpp	10	V	Between any terminals

### **3.2 Electrical Characteristics**

Source impedance		$Zs=50 \Omega$						
Load	impedance		$Z_L=2k \Omega //3pF$			$T_A=25$ °C		
	Item	ı	Freq	min	typ	max		
	Insertion attenuation Reference level		54.25MHz	11.5	13.5	15.5	dB	
			53.95MHz			2.6	dB	
			54.55MHz			3.4	dB	
	Relative att	onvotion	55.17MHz	19			dB	
	Kelative att	enuation	52.75MHz	40			dB	
			58.75MHZ	40			dB	
			60.25MHz	40			dB	
	Sidelobe		52.75MHz	35.0			dB	
			66.00MHz	35.0			dB	
	Temperature coeffic		ficient		-18		ppm/k	

### **3.3Environmental Performance Characteristics**

Item	Conditio	n		Specifications
High temperature	The specimen shall be store 85±2℃ for 96±4h. Then it standard atmospheric cond which measurement shall be	shall be subjec itions for 1h,	ted to after	
Low temperature	The specimen shall be store $-40\pm3$ °C for 96 $\pm4h$ . Then it standard atmospheric cond which measurement shall be	t shall be subjec litions for 1h,	ted to after	
Humidity	The specimen shall be store 40±2°C with relative humic for 96±4h. Then it shall be atmospheric conditions for measurement shall be made	dity of 90% to subjected to sta or 1h, after	96% ndard	Mechanical characteristics and specifications in electrical characteristics shall
Thermal shock	The specimen shall be subjected to standard atmost 1h, after which measurem within 1h. Temperature $1 + 25^{\circ}C = >-40^{\circ}C$	ected to 8 continues. Then it sha	all be ns for	be satisfied. There shall be no excessive change in appearance.

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	1		TT		
	2	-40°C	4h		
	3	-40°C=>+85°C	2h		
	4	+85℃	4h		
	5	+85°C=>+25°C	0.5h		
	6	+25℃	1h		
Resistance to	Reflow	soldering method			
Soldering	Peak: 25	$55 \pm 5$ °C, $220 \pm 5$ °C	2, 40s		
heat	At elect	rode temperature of	the specimen.		
	300 — 250 — 200 = 200 — 200 = 200 — 200 = 200 — 200 =	Temperature profi	le of reflow soldering ring Slow cooling (St room tempe 2 min. or more		
	-	cimen shall be passe	0		
		with the condition	shown in the a	above	
	-	for 1 time.			
	-	becimen shall be			
	-	neric conditions for			
		ement shall be made			
		thick. Base materia	I shall be glass f	tabric	
	-	oxy resin.	1		
Solder ability		e the pins melt sol	der at $260^{\circ}C+5$	/-0°C	More then 95% of
	for 5 sec	2.			total area of the
					pins should be
					covered with solder

#### **3.4Mechanical Test**

Items	Conditions	Specifications
Vibration	600-3300rpm amplitude 1.5mm	
	3 directions 2 H each	
Drop	On maple plate from 1m high 3 times	
		There shall be no
Lead pull	Pull with 1kg force for 30 seconds	damage.
Lead bend	90° bending with 500g weigh 2 times	

#### **3.5Voltage Discharge Test**

Item	Condition	Specifications
Surge	Between any two electrode	
		There shall be no damage

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#### **3.6 Frequency response**

